

NVATS4A101PZ

Power MOSFET

-30 V, 30 mΩ, -27 A, P-Channel



ON Semiconductor®

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The NVATS4A101PZ is a power MOSFET designed for compact size and high efficiency which can achieve high thermal performance. AEC-Q101 qualified MOSFET and PPAP capable suitable for automotive applications.

Features

- Low On-Resistance
- High Current Capability
- 100% Avalanche Tested
- AEC-Q101 qualified and PPAP capable
- ATPAK package is pin-compatible with DPAK (TO-252)
- Pb-Free, Halogen Free and RoHS compliance

Typical Applications

- Reverse Battery Protection
- Load Switch
- Automotive Front Lighting
- Automotive Body Controllers

SPECIFICATIONS

ABSOLUTE MAXIMUM RATING at Ta = 25°C (Note 1)

Parameter	Symbol	Value	Unit
Drain to Source Voltage	V _{DSS}	-30	V
Gate to Source Voltage	V _{GSS}	±20	V
Drain Current (DC)	I _D	-27	A
Drain Current (Pulse) PW ≤ 10 μs, duty cycle ≤ 1%	I _{DP}	-81	A
Power Dissipation Tc = 25°C	P _D	36	W
Operating Junction and Storage Temperature	T _J , T _{stg}	-55 to +175	°C
Avalanche Energy (Single Pulse) (Note 2)	E _{AS}	25	mJ
Avalanche Current (Note 3)	I _{AV}	-13	A

Note 1 : Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

2 : V_{DD} = -10 V, L = 200 μH, I_{AV} = -13 A

3 : L ≤ 200 μH, Single pulse

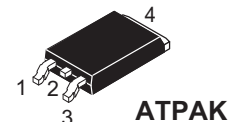
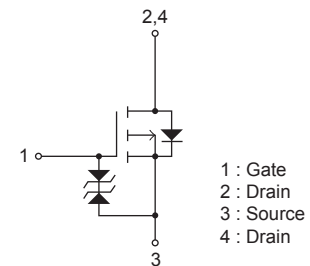
THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction to Case Steady State (Tc = 25°C)	R _{θJC}	4.1	°C/W
Junction to Ambient (Note 4)	R _{θJA}	80.7	°C/W

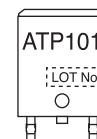
Note 4 : Surface mounted on FR4 board using a 130 mm², 1 oz. Cu pad.

V _{DSS}	R _{DS(on)} Max	I _D Max
-30 V	30 mΩ @ -10 V	-27 A
	51 mΩ @ -4.5 V	

ELECTRICAL CONNECTION P-Channel



MARKING



ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

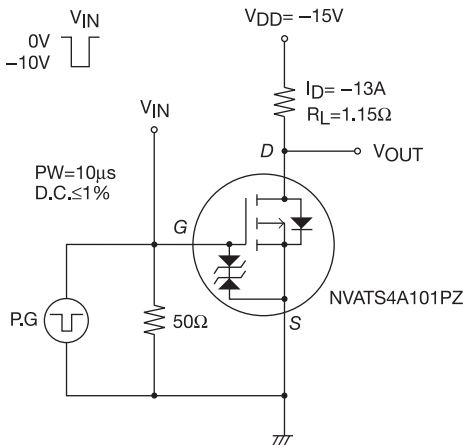
NVATS4A101PZ

ELECTRICAL CHARACTERISTICS at Ta = 25°C (Note 5)

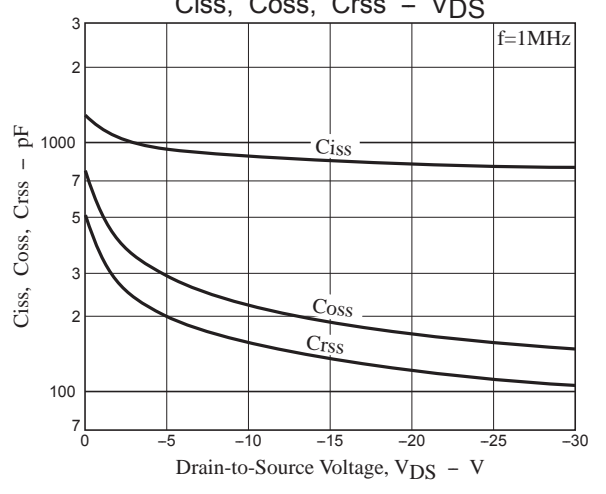
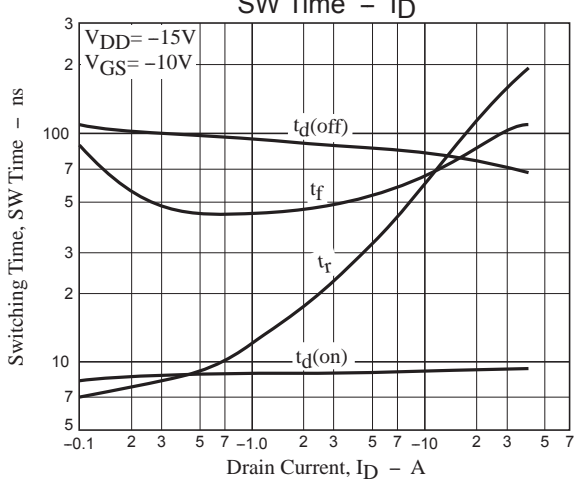
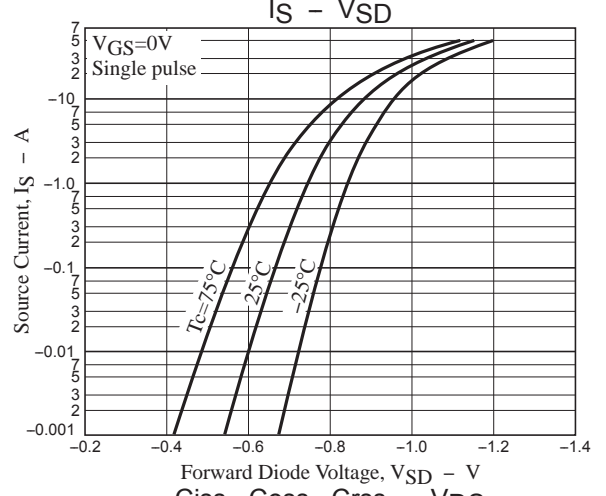
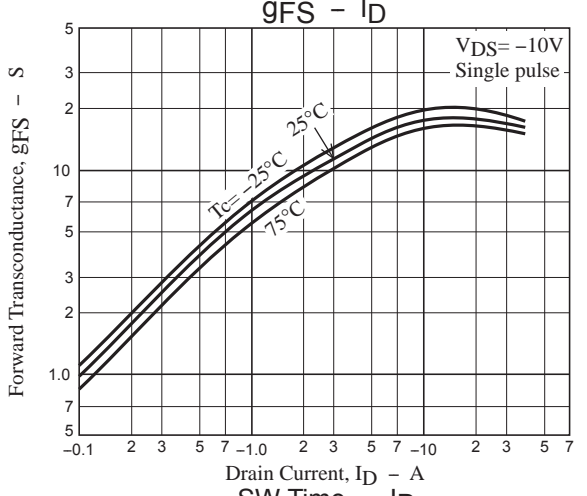
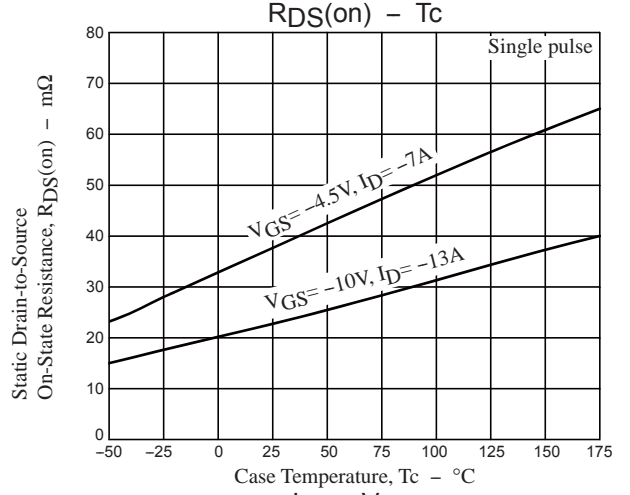
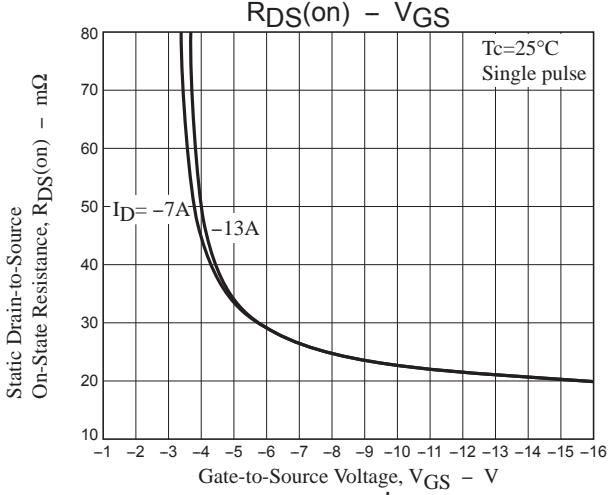
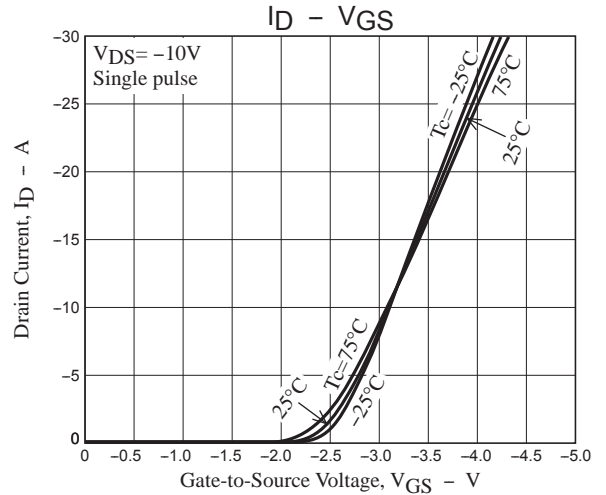
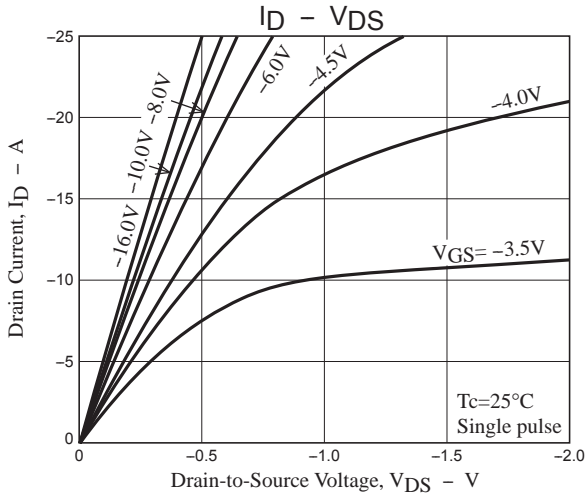
Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
Drain to Source Breakdown Voltage	V(BR)DSS	$I_D = -1 \text{ mA}, V_{GS} = 0 \text{ V}$	-30			V
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μA
Gate to Source Leakage Current	I_{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$			± 10	μA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	-1.2		-2.6	V
Forward Transconductance	g_{FS}	$V_{DS} = -10 \text{ V}, I_D = -13 \text{ A}$		17		S
Static Drain to Source On-State Resistance	$R_{DS(on)1}$	$I_D = -13 \text{ A}, V_{GS} = -10 \text{ V}$		23	30	$\text{m}\Omega$
	$R_{DS(on)2}$	$I_D = -7 \text{ A}, V_{GS} = -4.5 \text{ V}$		36	51	$\text{m}\Omega$
Input Capacitance	C_{iss}	$V_{DS} = -10 \text{ V}, f = 1 \text{ MHz}$		875		pF
Output Capacitance	C_{oss}			220		pF
Reverse Transfer Capacitance	C_{rss}			155		pF
Turn-ON Delay Time	$t_{d(on)}$		See Fig.1		9.2	
Rise Time	t_r			70		ns
Turn-OFF Delay Time	$t_{d(off)}$			80		ns
Fall Time	t_f			70		ns
Total Gate Charge	Q_g	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -25 \text{ A}$		18.5		nC
Gate to Source Charge	Q_{gs}			3.2		nC
Gate to Drain "Miller" Charge	Q_{gd}			4.0		nC
Forward Diode Voltage	V_{SD}		$I_S = -25 \text{ A}, V_{GS} = 0 \text{ V}$		-0.99	-1.5

Note 5 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

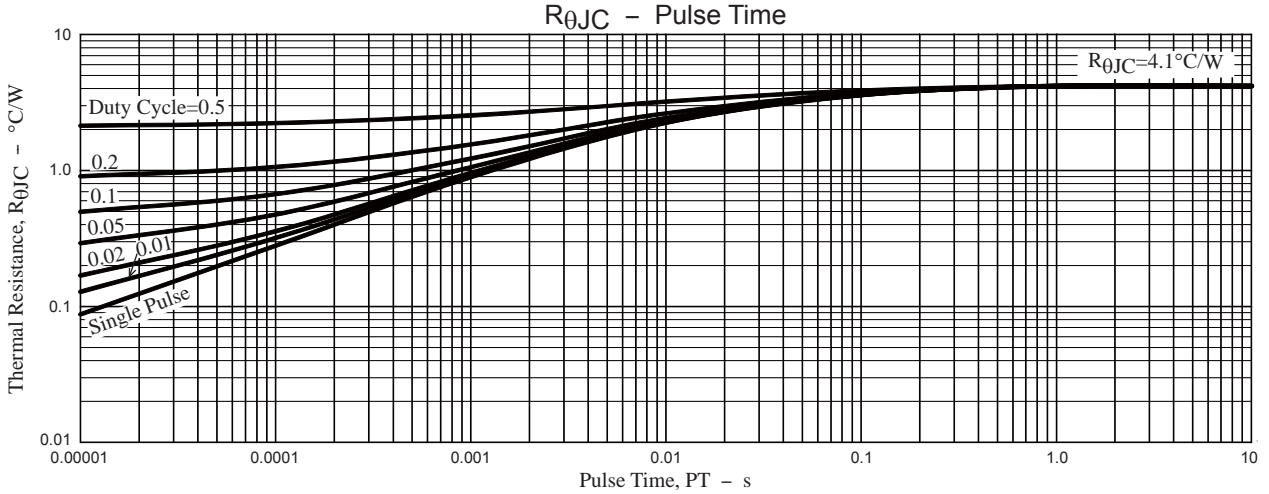
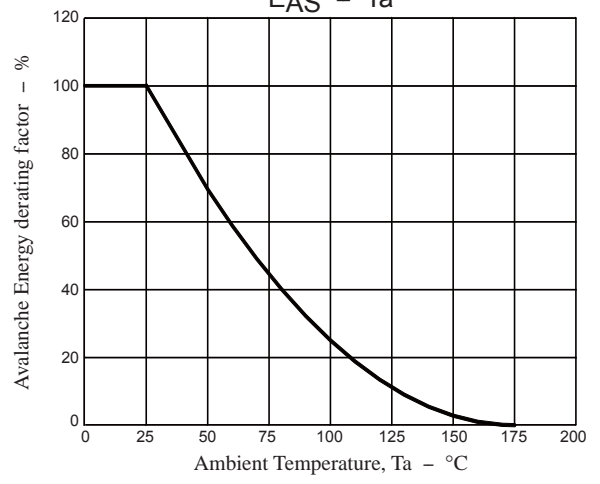
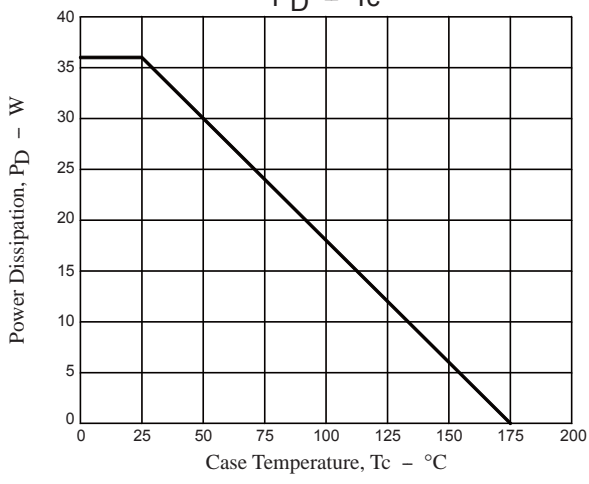
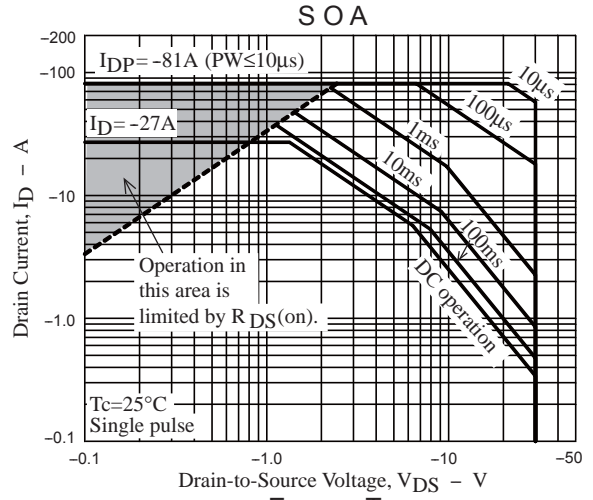
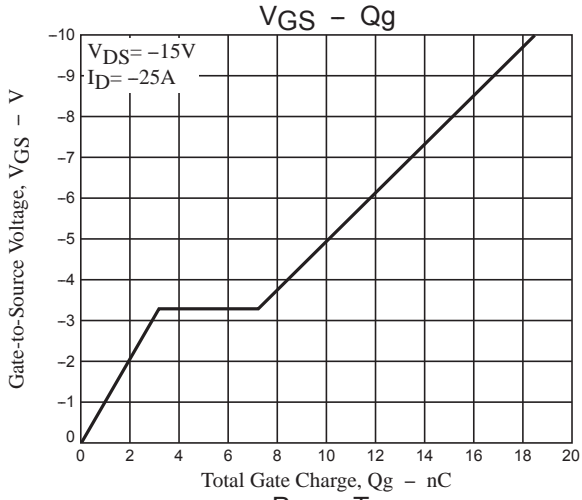
Fig.1 Switching Time Test Circuit



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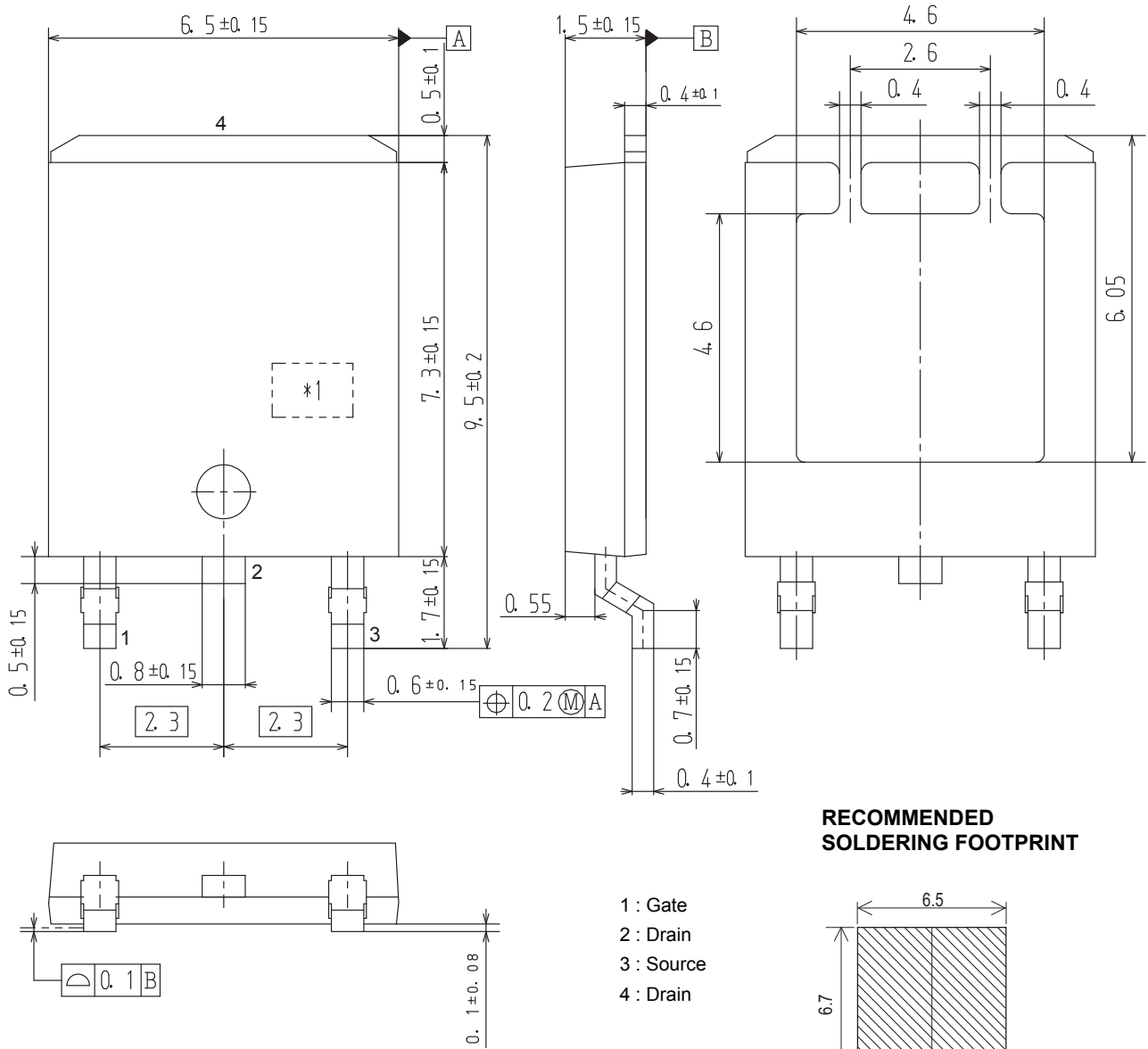
PACKAGE DIMENSIONS

unit : mm

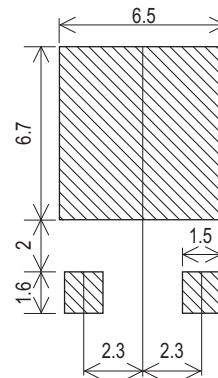
DPAK (Single Gauge) / ATPAK

CASE 369AM

ISSUE O



RECOMMENDED SOLDERING FOOTPRINT



Pin2 is idle pin with electrical designation only carried

*1: Lot indication

NVATS4A101PZ

ORDERING INFORMATION

Device	Marking	Package	Shipping (Qty / Packing)
NVATS4A101PZT4G	ATP101	DPAK(Single Gauge) / ATPAK (Pb-Free / Halogen Free)	3,000 / Tape & Reel

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

Note on usage : Since the NVATS4A101PZ is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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